ABBOCIATION CONNECTING ALECTRONICS INDUSTRIES® International and I	position De . IPC, Bannockt Pan-American co	c laration ourn, Illinois. <i>A</i> opyright conve	All rights reserved u ntions.	nder both	This docume level parts, th	ent is a declaration en declaration	on of the substan	ces within the man ower level material	ufacturer liste s for which the	d item. Note: i e manufacture	if the item is an as r has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distribution								Materials and	ials and Mfg Information			
upplier Information													
ompany name*	Company un	Company unique ID			Unique ID Authority				Response Date*				
onsemi										2024-05-07			
Contact Name Title -			Title - Contact			Phone - Contact*			Emai	Email - Contact*			
Product-Env-Stewards Pro			Product Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title -			itle - Representative			Phone - Representative*			Emai	Email - Representative*			
Product-Env-Stewards Pro-			Product Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number	Mfr Item Name		·	Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	LP29504	LP2950ACZ-3.3G ANA 100M		AA 3.3V LDO VREG		2024-05-07	CNF			198.01	mg	Each	
Ianufacturing Proccess Inform	ation												
Terminal Plating / Grid Array	Cerminal Plating / Grid Array Material Terminal Base		Alloy J-STD-020 MSL Rati		L Rating	Peak Process Body Temperature Max Time		it Peak Tempe	ak Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed		CU Alloy NA		NA		0 C		30	sec	conds 3			
omments													
or more information regarding materi	al composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl bhthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.2	mg	Supplier	Silicon (Si)	7440-21-3		3.2	mg
Die Attach	5.15	mg	Supplier	Silver (Ag)	7440-22-4		4.3775	mg
			Supplier	Phenolic Resin	Proprietary Data		0.7725	mg
Lead Frame	80.67	mg	Supplier	Silver (Ag)	7440-22-4		0.0081	mg
			Supplier	Iron (Fe)	7439-89-6		0.0807	mg
			Supplier	Copper (Cu)	7440-50-8		80.5571	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0242	mg
Mold Compound-Black	106.15	mg		Phenol Resin	proprietary data		10.615	mg
			Supplier	Carbon Black (C)	1333-86-4		1.0615	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		81.7355	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		12.738	mg
Plating	2.74	mg	Supplier	Tin (Sn)	7440-31-5		2.74	mg
Wire Bond - Au	0.1	mg	Supplier	Gold (Au)	7440-57-5		0.1	mg